



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov

BIBDATASHEET

CONFIRMATION NO. 4215

Bib Data Sheet

SERIAL NUMBER 10/782,270	FILING DATE 02/18/2004 RULE	CLASS 257	GROUP ART UNIT 2815	ATTORNEY DOCKET NO. 2269-4973.1US (00-0593.01)
-----------------------------	---------------------------------------	--------------	------------------------	---

APPLICANTS

Teck Kheng Lee, Singapore, SINGAPORE; *nbe*

** CONTINUING DATA *****

This application is a CON of 10/150,902 05/17/2002 *nbe*

** FOREIGN APPLICATIONS *****

SINGAPORE 200201301-9 03/04/2002 *nbe*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 05/13/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY SINGAPORE	SHEETS DRAWING 18	TOTAL CLAIMS 26	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged <i>James L. Lee</i> Examiner's Signature <i>nbe</i> Initials				

ADDRESS

24247
TRASK BRITT
P.O. BOX 2550
SALT LAKE CITY, UT
84110

TITLE

Interposer substrate and wafer scale interposer substrate member for use with flip-chip configured semiconductor dice

FILING FEE RECEIVED 878	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____
-----------------------------------	---	--